256M AND type Flash Memory More than 16,057-sector (271,299,072-bit)

# **HITACHI**

ADE-203-995B (Z) Rev. 1.0 Dec. 10, 1999

## **Description**

The Hitachi HN29W25611 Series is a CMOS Flash Memory with AND type multi-level memory cells. It has fully automatic programming and erase capabilities with a single 3.3 V power supply. The functions are controlled by simple external commands. To fit the I/O card applications, the unit of programming and erase is as small as (2048 + 64) bytes. Initial available sectors of HN29W25611 are more than 16,057 (98% of all sector address) and less than 16,384 sectors.

#### **Features**

- On-board single power supply ( $V_{CC}$ ):  $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$
- Organization
  - AND Flash Memory: (2048 + 64) bytes  $\times$  (More than 16,057 sectors)
  - Data register: (2048 + 64) bytes
- Multi-level memory cell
  - 2 bit/per memory cell
- Automatic programming
  - Sector program time: 3.0 ms (typ)
  - System bus free
  - Address, data latch function
  - Internal automatic program verify function
  - Status data polling function
- Automatic erase
  - Single sector erase time: 1.5 ms (typ)
  - System bus free
  - Internal automatic erase verify function
  - Status data polling function

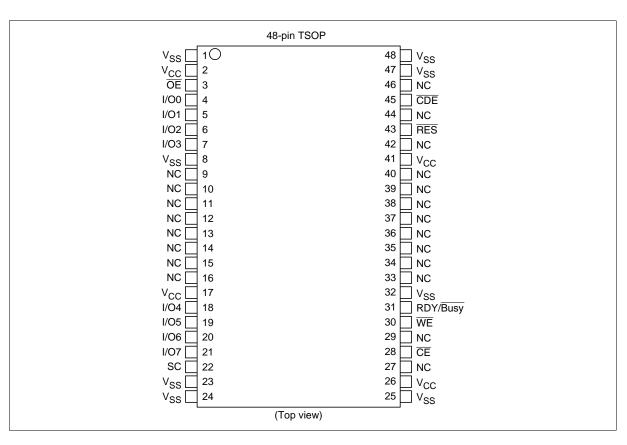


- Erase mode
  - Single sector erase ((2048 + 64) byte unit)
- Fast serial read access time:
  - First access time: 50 µs (max)
  - Serial access time: 50 ns (max)
- Low power dissipation:
  - $I_{CC2} = 50 \text{ mA (max) (Read)}$
  - $I_{SB2} = 50 \mu A \text{ (max) (Standby)}$
  - $--I_{CC3}/I_{CC4} = 40 \text{ mA (max) (Erase/Program)}$
  - $I_{SB3} = 5 \mu A \text{ (max) (Deep standby)}$
- The following architecture is required for data reliability.
  - Error correction: more than 3-bit error correction per each sector read
  - Spare sectors: 1.8% (290 sectors) within usable sectors

# **Ordering Information**

| Type No.       | Available sector         | Package  |
|----------------|--------------------------|--|
| HN29W25611T-50 | More than 16,057 sectors | $12.0 \times 18.40 \text{ mm}^2 0.5 \text{ mm pitch}$<br>48-pin plastic TSOP I (TFP-48D) |

## **Pin Arrangement**

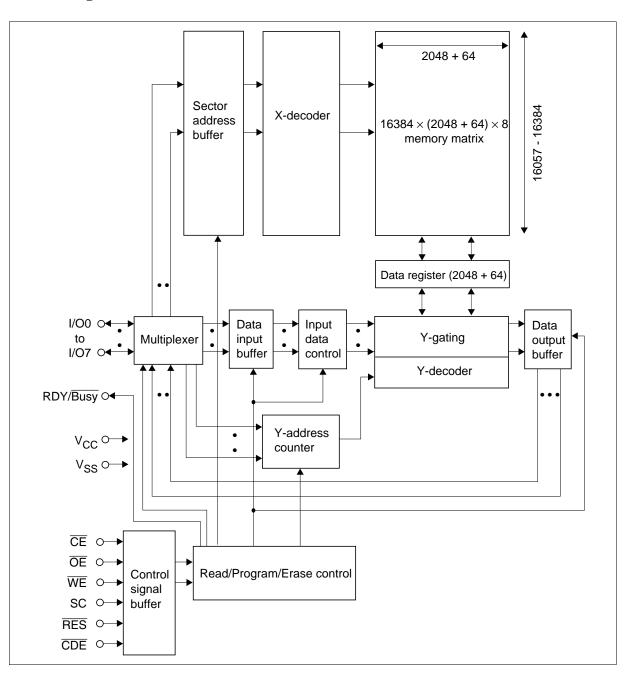


# **Pin Description**

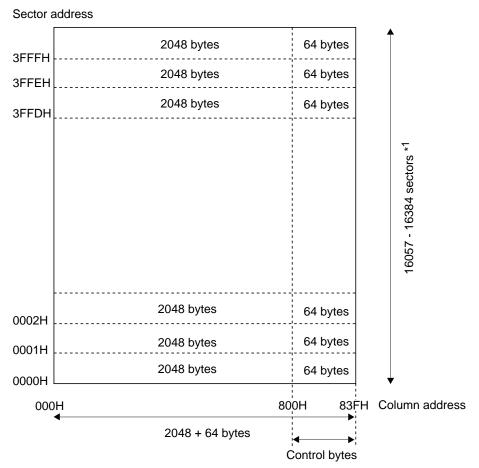
| Pin name           | Function            |
|--------------------|---------------------|
| I/O0 to I/O7       | Input/output        |
| CE                 | Chip enable         |
| ŌĒ                 | Output enable       |
| WE                 | Write enable        |
| CDE                | Command data enable |
| V <sub>cc</sub> *1 | Power supply        |
| V <sub>SS</sub> *1 | Ground              |
| RDY/Busy           | Ready/Busy          |
| RES                | Reset               |
| SC                 | Serial clock        |
| NC                 | No connection       |

Note: 1. All  $V_{cc}$  and  $V_{ss}$  pins should be connected to a common power supply and a ground, respectively.

# **Block Diagram**



## **Memory Map and Address**



| Address        | Cycles              | I/O0   | I/O1 | I/O2 | I/O3 | I/O4 | I/O5 | I/O6 | I/O7 |
|----------------|---------------------|--------|------|------|------|------|------|------|------|
| Sector address | SA (1): First cycle | A0     | A1   | A2   | A3   | A4   | A5   | A6   | A7   |
|                | SA (2): Second cy   | cle A8 | A9   | A10  | A11  | A12  | A13  | ×*2  | ×    |
| Column address | CA (1): First cycle | A0     | A1   | A2   | A3   | A4   | A5   | A6   | A7   |
|                | CA (2): Second cy   | cle A8 | A9   | A10  | A11  | ×    | ×    | ×    | ×    |

Notes: 1. Some failed sectors may exist in the device. The failed sectors can be recognized by reading the sector valid data written in a part of the column address 800 to 83F (The specific address is TBD.). The sector valid data must be read and kept outside of the sector before the sector erase. When the sector is programmed, the sector valid data should be written back to the sector.

2. An  $\times$  means "Don't care". The pin level can be set to either  $V_{IL}$  or  $V_{IH}$ , referred to DC characteristics.

#### Pin Function

 $\overline{\text{CE}}$ :  $\overline{\text{CE}}$  is used to select the device. The status returns to the standby at the rising edge of  $\overline{\text{CE}}$  in the reading operation. However, the status does not return to the standby at the rising edge of  $\overline{\text{CE}}$  in the busy state in programming and erase operation.

 $\overline{\text{OE}}$ : Memory data and status register data can be read, when  $\overline{\text{OE}}$  is  $V_{IL}$ .

 $\overline{\text{WE}}$ : Commands and address are latched at the rising edge of  $\overline{\text{WE}}$ .

SC: Programming and reading data is latched at the rising edge of SC.

 $\overline{\text{RES}}$ :  $\overline{\text{RES}}$  pin must be kept at the  $V_{ILR}$  ( $V_{SS} \pm 0.2$  V) level when  $V_{CC}$  is turned on and off. In this way, data in the memory is protected against unintentional erase and programming.  $\overline{\text{RES}}$  must be kept at the  $V_{IHR}$  ( $V_{CC} \pm 0.2$  V) level during any operations such as programming, erase and read.

 $\overline{\text{CDE}}$ : Commands and data are latched when  $\overline{\text{CDE}}$  is  $V_{IL}$  and address is latched when  $\overline{\text{CDE}}$  is  $V_{IH}$ .

**RDY/Busy:** The RDY/Busy indicates the program/erase status of the flash memory. The RDY/Busy signal is initially at a high impedance state. It turns to a  $V_{OL}$  level after the (40H) command in programming operation or the (B0H) command in erase operation. After the erase or programming operation finishes, the RDY/Busy signal turns back to the high impedance state.

**I/O0 to I/O7:** The I/O pins are used to input data, address and command, and are used to output memory data and status register data.

#### Mode Selection

| Mode                   | CE              | OE              | WE              | SC              | RES              | CDE             | RDY/Busy*3      | I/O0 to I/O7            |
|------------------------|-----------------|-----------------|-----------------|-----------------|------------------|-----------------|-----------------|-------------------------|
| Deep standby           | ×* <sup>4</sup> | ×               | ×               | ×               | $V_{ILR}$        | ×               | V <sub>OH</sub> | High-Z                  |
| Standby                | $V_{\text{IH}}$ | ×               | ×               | ×               | $V_{\text{IHR}}$ | ×               | $V_{OH}$        | High-Z                  |
| Output disable         | V <sub>IL</sub> | V <sub>IH</sub> | $V_{IH}$        | ×               | $V_{\text{IHR}}$ | ×               | V <sub>OH</sub> | High-Z                  |
| Status register read*1 | $V_{\text{IL}}$ | $V_{\text{IL}}$ | $V_{\text{IH}}$ | ×               | $V_{\text{IHR}}$ | ×               | $V_{OH}$        | Status register outputs |
| Command write*2        | $V_{\text{IL}}$ | $V_{\text{IH}}$ | $V_{\text{IL}}$ | $V_{\text{IL}}$ | $V_{\text{IHR}}$ | $V_{\text{IL}}$ | $V_{OH}$        | Din                     |

- Notes: 1. Default mode after the power on is the status register read mode (refer to status transition). From I/O0 to I/O7 pins output the status, when  $\overline{CE} = V_{IL}$  and  $\overline{OE} = V_{IL}$  (conventional read operation condition).
  - Refer to the command definition. Data can be read, programmed and erased after commands are written in this mode.
  - The RDY/Busy bus should be pulled up to V<sub>CC</sub> to maintain the V<sub>OH</sub> level while the RDY/Busy pin outputs a high impedance.
  - 4. An  $\times$  means "Don't care". The pin level can be set to either  $V_{IL}$  or  $V_{IH}$  referred to DC characteristics.

# $\ \ \, \textbf{Command Definition} \textbf{*}^{1,\,2}$

|                 |                 |                             |               | First bus c      | ycle    | Second bus cycle |          |               |  |
|-----------------|-----------------|-----------------------------|---------------|------------------|---------|------------------|----------|---------------|--|
| Command         |                 |                             | Bus<br>cycles | Operation mode*3 | Data in | Operation mode   | Data in  | Data out      |  |
| Read            | Serial read (1) | (Without CA)                | 3             | Write            | 00H     | Write            | SA (1)*4 |               |  |
|                 |                 | (With CA)                   | 3 + 2h*6      | Write            | 00H     | Write            | SA (1)*4 |               |  |
|                 | Serial read (2) |                             | 3             | Write            | F0H     | Write            | SA (1)*4 |               |  |
|                 | Read identifier | codes                       | 1             | Write            | 90H     | Read             |          | ID*8, 9       |  |
|                 | Data recovery   | read                        | 1             | Write            | 01H     | Read             |          | Recovery data |  |
| Auto erase      | Single sector   |                             | 4             | Write            | 20H     | Write            | SA (1)*4 |               |  |
| Auto program    | Program (1)     | (Without CA* <sup>7</sup> ) | 4             | Write            | 10H     | Write            | SA (1)*4 |               |  |
|                 |                 | (With CA*7)                 | 4 + 2h*6      | Write            | 10H     | Write            | SA (1)*4 |               |  |
|                 | Program (2)*10  |                             | 4             | Write            | 1FH     | Write            | SA (1)*4 |               |  |
|                 | Program (3) (0  | Control bytes)*7            | 4             | Write            | 0FH     | Write            | SA (1)*4 |               |  |
|                 | Program (4)     | (WithoutCA*7)               | 4             | Write            | 11H     | Write            | SA (1)*4 |               |  |
|                 |                 | (With CA*7)                 | 4 + 2h*6      | Write            | 11H     | Write            | SA (1)*4 |               |  |
| Reset           |                 |                             | 1             | Write            | FFH     |                  |          |               |  |
| Clear status re | egister         |                             | 1             | Write            | 50H     |                  |          |               |  |
| Data recovery   | write           |                             | 4             | Write            | 12H     | Write            | SA (1)*4 |               |  |

|                 |                 |                             |               | Third bus c    | ycle     | Fourth bus     | cycle      |
|-----------------|-----------------|-----------------------------|---------------|----------------|----------|----------------|------------|
| Command         |                 |                             | Bus<br>cycles | Operation mode | Data in  | Operation mode | Data in    |
| Read            | Serial read (1) | (Without CA)                | 3             | Write          | SA (2)*4 |                |            |
|                 |                 | (With CA)                   | 3 + 2h*6      | Write          | SA (2)*4 | Write          | CA (1)*5   |
|                 | Serial read (2) |                             | 3             | Write          | SA (2)*4 |                |            |
|                 | Read identifier | codes                       | 1             |                |          |                |            |
|                 | Data recovery   | read                        | 1             |                |          |                |            |
| Auto erase      | Single sector   |                             | 4             | Write          | SA (2)*4 | Write          | B0H*11     |
| Auto program    | Program (1)     | (Without CA* <sup>7</sup> ) | 4             | Write          | SA (2)*4 | Write          | 40H*11, 12 |
|                 |                 | (With CA*7)                 | 4 + 2h*6      | Write          | SA (2)*4 | Write          | CA (1)     |
|                 | Program (2)*10  |                             | 4             | Write          | SA (2)*4 | Write          | 40H*11, 12 |
|                 | Program (3) (0  | Control bytes)*7            | 4             | Write          | SA (2)*4 | Write          | 40H*11, 12 |
|                 | Program (4)     | (WithoutCA*7)               | 4             | Write          | SA (2)*4 | Write          | 40H*11, 12 |
|                 |                 | (With CA*7)                 | 4 + 2h*6      | Write          | SA (2)*4 | Write          | CA (1)     |
| Reset           |                 |                             | 1             |                |          |                |            |
| Clear status re | egister         |                             | 1             |                |          |                |            |
| Data recovery   | write           |                             | 4             | Write          | SA (2)*4 | Write          | 40H*11, 12 |

|                 |                 |                             |                | Fifth bus cy   | /cle     | Sixth bus c    | ycle       |
|-----------------|-----------------|-----------------------------|----------------|----------------|----------|----------------|------------|
| Command         |                 |                             | Bus<br>cycles  | Operation mode | Data in  | Operation mode | Data in    |
| Read            | Serial read (1) | (Without CA)                | 3              |                |          |                |            |
|                 |                 | (With CA)                   | 3 + 2h*6       | Write          | CA (2)*5 |                |            |
|                 | Serial read (2) |                             | 3              |                |          |                |            |
|                 | Read identifie  | r codes                     | 1              |                |          |                |            |
|                 | Data recovery   | read                        | 1              |                |          |                |            |
| Auto erase      | Single sector   |                             | 4              |                |          |                |            |
| Auto program    | Program (1)     | (Without CA* <sup>7</sup> ) | 4              |                |          |                |            |
|                 |                 | (With CA*7)                 | 4 + 2h*6       | Write          | CA (2)*5 | Write          | 40H*11, 12 |
|                 | Program (2)*10  | 0                           | 4              |                |          |                |            |
|                 | Program (3) (   | Control bytes)*             | <sup>7</sup> 4 |                |          |                |            |
|                 | Program (4)     | (WithoutCA*7)               | 4              |                |          |                |            |
|                 |                 | (With CA*7)                 | 4 + 2h*6       | Write          | CA (2)   | Write          | 40H*11, 12 |
| Reset           |                 |                             | 1              |                |          |                |            |
| Clear status re | egister         |                             | 1              |                |          |                |            |
| Data recovery   | write           |                             | 4              |                |          |                |            |

Notes: 1. Commands and sector address are latched at rising edge of WE pulses. Program data is latched at rising edge of SC pulses.

- 2. The chip is in the read status register mode when  $\overline{RES}$  is set to  $V_{IHR}$  first time after the power up.
- 3. Refer to the command read and write mode in mode selection.
- 4. SA (1) = Sector address (A0 to A7), SA (2) = Sector address (A8 to A13).
- 5. CA (1) = Column address (A0 to A7), CA (2) = Column address (A8 to A11).  $(0 \le A11 \text{ to } A0 \le 83\text{FH})$
- The variable h is the input number of times of set of CA (1) and CA (2) (1 ≤ h ≤ 2048 + 64).
   Set of CA (1) and CA (2) can be input not only one time but free times.
- 7. By using program (1) and (3), data can additionally be programmed for each sector before erase.
- 8. ID = Identifier code; Manufacturer code (07H), Device code (99H).
- 9. The manufacturer identifier code is output when  $\overline{CDE}$  is low and the device identifier code is output when  $\overline{CDE}$  is high.
- 10. Before program (2) operations, data in the programmed sector must be erased.
- 11. No commands can be written during auto program and erase (when the RDY/ $\overline{\text{Busy}}$  pin outputs a  $V_{\text{Ol}}$ ).
- 12. The fourth or sixth cycle of the auto program comes after the program data input is complete.

## **Mode Description**

#### Read

**Serial Read (1):** Memory data D0 to D2111 in the sector of address SA is sequentially read. Output data is not valid after the number of the SC pulse exceeds 2112. When CA is input, memory data D (m) to D (m + j) in the sector of address SA is sequentially read. Then output data is not valid after the number of the SC pulse exceeds (2112 to m). The mode turns back to the standby mode at any time when  $\overline{\text{CE}}$  is  $V_{\text{IH}}$ .

**Serial Read (2):** Memory data D2048 to D2111 in the sector of address SA is sequentially read. Output data is not valid after the number of the SC pulse exceeds 64. The mode turns back to the standby mode at any time when  $\overline{\text{CE}}$  is  $V_{\text{IH}}$ .

#### **Automatic Erase**

**Single Sector Erase:** Memory data D0 to D2111 in the sector of address SA is erased automatically by internal control circuits. After the sector erase starts, the erasure completion can be checked through the RDY/Busy signal and status data polling. All the bits in the sector are "1" after the erase. The sector valid data stored in a part of memory data D2048 to D2111 must be read and kept outside of the sector before the sector erase.

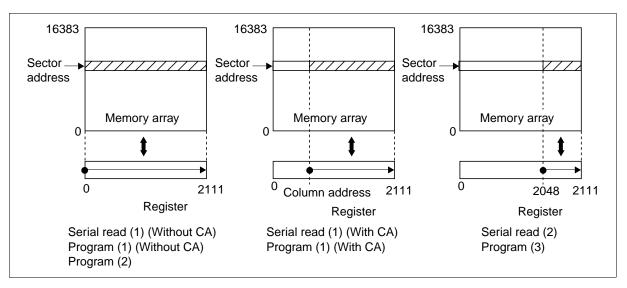
### **Automatic Program**

**Program (1):** Program data PD0 to PD2111 is programmed into the sector of address SA automatically by internal control circuits. When CA is input, program data PD (m) to PD (m + j) is programmed from CA into the sector of address SA automatically by internal control circuits. By using program (1), data can additionally be programed for each sector before the following erase. When the column is programmed, the data of the column must be [FF]. After the programming starts, the program completion can be checked through the RDY/Busy signal and status data polling. Programmed bits in the sector turn from "1" to "0" when they are programmed. The sector valid data should be included in the program data PD2048 to PD2111.

**Program (2):** Program data PD0 to PD2111 is programmed into the sector of address SA automatically by internal control circuits. After the programming starts, the program completion can be checked through the RDY/Busy signal and status data polling. Programmed bits in the sector turn from "1" to "0" when they are programmed. The sector must be erased before programming. The sector valid data should be included in the program data PD2048 to PD2111.

**Program (3):** Program data PD2048 to PD2111 is programmed into the sector of address SA automatically by internal control circuits. By using program (3), data can additionally be programed for each sector befor the following erase. When the column is programmed, the data of the column must be [FF]. After the programming starts, the program completion can be checked through the RDY/Busy signal and status data polling. Programmed bits in the sector turn from "1" to "0" when they are programmed.

**Program (4):** Program data PD0 to PD2111 is programmed into the sector of address SA automatically by internal control circuits. When CA is input, program data PD (m) to PD (m + j) is programmed from CA into the sector of address SA automatically by internal control circuits. By using program (4), data can be rewritten for each sector before the following erase. So the column data before programming operation are either "1" or "0". In this mode, E/W number of times must be counted whenever program (4) execute. After the programming starts, the program completion can be checked through the RDY/Busy signal and status data polling. The sector valid data should be included in the program data PD2048 to PD2111.



### Status Register Read

The status returns to the status register read mode from standby mode, when  $\overline{CE}$  and  $\overline{OE}$  is  $V_{IL}$ . In the status register read mode, I/O pins output the same operation status as in the status data polling defined in the function description.

#### **Identifier Read**

The manufacturer and device identifier code can be read in the identifier read mode. The manufacturer and device identifier code is selected with  $\overline{\text{CDE}} \, V_{IL}$  and  $V_{IH}$ , respectively.

### **Data Recovery Read**

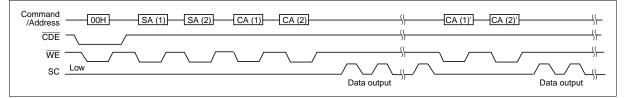
When the programming was an error, the program data can be read by using data recovery read. When an additional programming was an error, the data compounded of the program data and the origin data in the sector address SA can be read. Output data are not valid after the number of SA pulse exceeds 2112. The mode turns back to the standby mode at any time when  $\overline{CE}$  is  $V_{IH}$ . The read data are invalid when addresses are latched at a rising edge of  $\overline{WE}$  pulse after the data recovery read command is written.

### **Data Recovery Write**

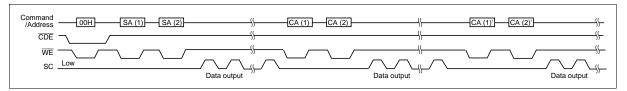
When the programming into a sector of address SA was an error, the program data can be rewritten automatically by internal control circuit into the other selected sector of address SA'. In this case, top address [SA13] of sector of address SA' must be the same as SA. Since the data recovery write mode is internally Program (4) mode, rewritten sector of address SA' needs no sector erase before rewrite. After the data recovery write mode starts, the program completion can be checked through the RDY/Busy signal and the status data polling.

## Command/Address/Data Input Sequence

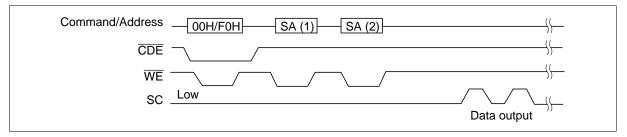
### Serial Read (1) (With CA before SC)



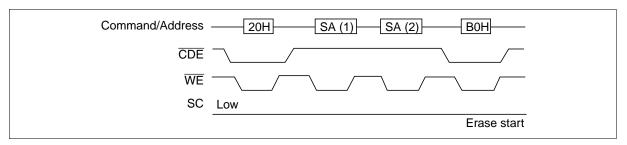
## Serial Read (1) (With CA after SC)



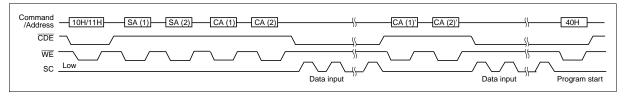
### Serial Read (1) (Without CA), (2)



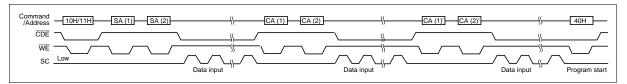
## **Single Sector Erase**



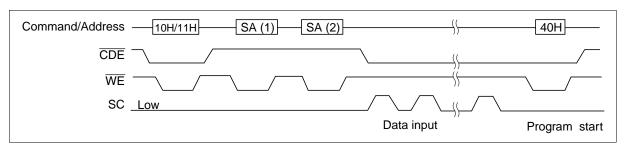
### Program (1), (4) (With CA before SC)



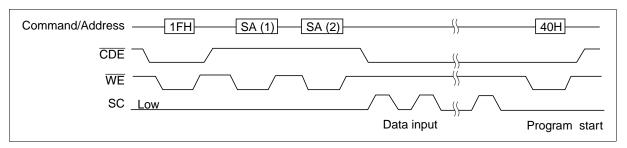
### Program (1), (4) (With CA after SC)



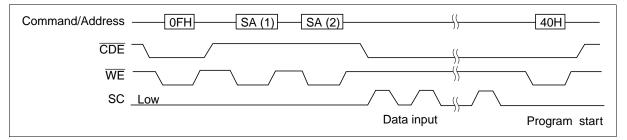
### Program (1), (4) (Without CA)



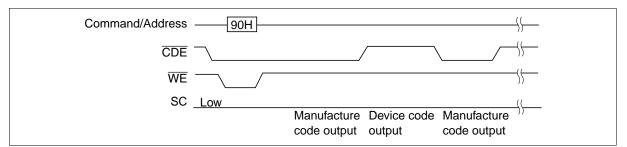
### Program (2)



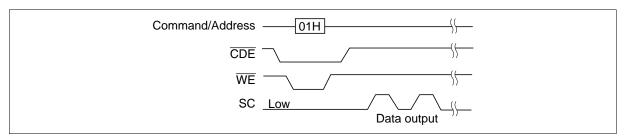
### Program (3)



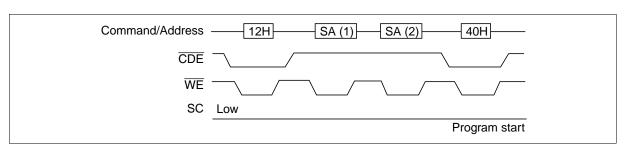
### **ID Read Mode**



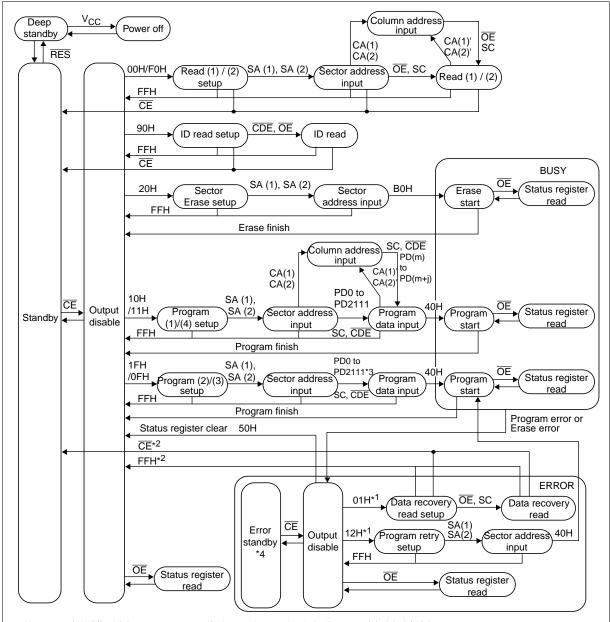
### **Data Recovery Read Mode**



## **Data Recovery Write Mode**



### **Status Transition**



Notes: 1. (01H)/(12H) Data recovery read/write can be used only for Program (1), (2), (3), (4) errors.

- 2. When reset is done by  $\overline{\text{CE}}$  or FFH, error status flag is cleared.
- 3. When Program (3) mode, input data is PD2048 to PD2111.
- 4. When Error standby,  $I_{\text{CC3}}$  level is current.

# **Absolute Maximum Ratings**

| Parameter                      | Symbol          | Value       | Unit | Notes |
|--------------------------------|-----------------|-------------|------|-------|
| V <sub>cc</sub> voltage        | V <sub>cc</sub> | -0.6 to +7  | V    | 1     |
| V <sub>SS</sub> voltage        | $V_{ss}$        | 0           | V    |       |
| All input and output voltages  | Vin, Vout       | -0.6 to +7  | V    | 1, 2  |
| Operating temperature range    | Topr            | 0 to +70    | °C   |       |
| Storage temperature range      | Tstg            | -65 to +125 | °C   | 3     |
| Storage temperature under bias | Tbias           | -10 to +80  | °C   |       |

Notes: 1. Relative to V<sub>ss</sub>.

2. Vin, Vout = -2.0 V for pulse width  $\leq 20$  ns.

3. Device storage temperature range before programming.

# **Capacitance** ( $Ta = 25^{\circ}C$ , f = 1 MHz)

| Parameter          | Symbol | Min | Тур | Max | Unit | Test conditions |
|--------------------|--------|-----|-----|-----|------|-----------------|
| Input capacitance  | Cin    | _   | _   | 6   | рF   | Vin = 0 V       |
| Output capacitance | Cout   | _   | _   | 12  | pF   | Vout = 0 V      |

## **DC Characteristics** ( $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ , $Ta = 0 \text{ to } +70^{\circ}\text{C}$ )

| Parameter                                   | Symbol           | Min                   | Тур | Max                   | Unit | Test conditions   |
|---|------------------|-----------------------|-----|-----------------------|------|---|
| Input leakage current                       | I <sub>LI</sub>  | _                     | _   | 2                     | μΑ   | $Vin = V_{SS} to V_{CC}$  |
| Output leakage current                      | I <sub>LO</sub>  | _                     | _   | 2                     | μΑ   | Vout = V <sub>ss</sub> to V <sub>cc</sub>   |
| Standby V <sub>cc</sub> current             | I <sub>SB1</sub> | _                     | 0.3 | 1                     | mA   | CE = V <sub>IH</sub>  |
|   | I <sub>SB2</sub> | _                     | 30  | 50                    | μΑ   | $\overline{CE} = V_{cc} \pm 0.2 \text{ V},$ $\overline{RES} = V_{cc} \pm 0.2 \text{ V}$ |
| Deep standby V <sub>cc</sub> current        | I <sub>SB3</sub> | _                     | 1   | 5                     | μΑ   | $\overline{\text{RES}} = V_{\text{SS}} \pm 0.2 \text{ V}$                               |
| Operating V <sub>cc</sub> current           | I <sub>CC1</sub> | _                     | 20  | 25                    | mA   | lout = $0 \text{ mA}$ , $f = 0.2 \text{ MHz}$   |
|   | I <sub>CC2</sub> | _                     | 30  | 50                    | mA   | lout = $0 \text{ mA}$ , $f = 20 \text{ MHz}$  |
| Operating V <sub>cc</sub> current (Program) | I <sub>CC3</sub> | _                     | 20  | 40                    | mA   | In programming  |
| Operating V <sub>cc</sub> current (Erase)   | I <sub>CC4</sub> | _                     | 20  | 40                    | mA   | In erase  |
| Input voltage                               | $V_{\text{IL}}$  | -0.3*1,2              | _   | 0.8                   | V    |   |
|   | $V_{\text{IH}}$  | 2.0                   | _   | $V_{CC} + 0.3^{*3}$   | V    |   |
| Input voltage (RES pin)                     | $V_{ILR}$        | -0.2                  | _   | 0.2                   | V    |   |
|   | V <sub>IHR</sub> | V <sub>CC</sub> - 0.2 | _   | V <sub>CC</sub> + 0.2 | V    |   |
| Output voltage                              | V <sub>OL</sub>  |                       |     | 0.4                   | V    | I <sub>OL</sub> = 2 mA  |
|   | V <sub>OH</sub>  | 2.4                   | _   | _                     | V    | $I_{OH} = -2 \text{ mA}$  |

Notes: 1.  $V_{IL}$  min = -1.0 V for pulse width  $\leq$  50 ns in the read operation.  $V_{IL}$  min = -2.0 V for pulse width  $\leq$  20 ns in the read operation.

- 2.  $V_{IL}$  min = -0.6 V for pulse width  $\leq$  20 ns in the erase/data programming operation.
- 3.  $V_{IH}$  max =  $V_{CC}$  + 1.5 V for pulse width  $\leq$  20 ns. If  $V_{IH}$  is over the specified maximum value, the operations are not guaranteed.

# **AC Characteristics** ( $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ , $Ta = 0 \text{ to } +70^{\circ}\text{C}$ )

### **Test Conditions**

• Input pulse levels: 0.4 V/2.4 V

• Input pulse levels for  $\overline{RES}$ : 0.2 V/V<sub>CC</sub> – 0.2 V

• Input rise and fall time:  $\leq 5$  ns

• Output load: 1 TTL gate + 100 pF (Including scope and jig.)

• Reference levels for measuring timing: 0.8 V, 1.8 V

# Power on and off, Serial Read Mode

| Write cycle time         t <sub>covc</sub> 120         —         ns           Serial clock cycle time         t <sub>cos</sub> 50         —         —         ns           Œ setup time         t <sub>cos</sub> 0         —         —         ns           Œ hold time         t <sub>cos</sub> 0         —         —         ns           Write pulse high time         t <sub>twen</sub> 60         —         —         ns           Address setup time         t <sub>twen</sub> 40         —         —         ns           Address setup time         t <sub>twen</sub> 50         —         —         ns           Address setup time         t <sub>twen</sub> 50         —         —         ns           Address setup time         t <sub>twen</sub> 50         —         —         ns           Address setup time         t <sub>twen</sub> 50         —         —         ns           Address setup time         t <sub>twen</sub> 50         —         —         ns           Data setup time tor         t <sub>twen</sub> 0         —         —         ns           SC to output delay         t <sub>twen</sub> 0         —         —         ns <t< th=""><th>Parameter</th><th>Symbol</th><th>Min</th><th>Тур</th><th>Max</th><th>Unit</th><th>Test conditions</th><th>Notes</th></t<>   | Parameter  | Symbol            | Min | Тур | Max | Unit | Test conditions  | Notes |
|--|--|-------------------|-----|-----|-----|------|--|-------|
| CE setup time         t <sub>CES</sub> 0         —         —         ns           CE hold time         t <sub>CEH</sub> 0         —         —         ns           Write pulse time         t <sub>WP</sub> 60         —         —         ns           Write pulse high time         t <sub>WPH</sub> 40         —         —         ns           Address setup time         t <sub>AS</sub> 50         —         —         ns           Address hold time         t <sub>AH</sub> 10         —         —         ns           Data setup time         t <sub>DS</sub> 50         —         —         ns           Data setup time         t <sub>DS</sub> 50         —         —         ns           SC to output delay         t <sub>SAC</sub> —         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>M</sub> OE setup time for SC         t <sub>OES</sub> 0         —         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>M</sub> OE setup time before read         t <sub>OEC</sub> 0         —         40         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>M</sub> OE setup time before read         t <sub>OEC</sub> 0         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>M</sub> OE setup t  | Write cycle time                                   | t <sub>cwc</sub>  | 120 | _   | _   | ns   |  |       |
| CE hold time         t <sub>CEH</sub> 0         —         —         ns           Write pulse time         t <sub>WP</sub> 60         —         —         ns         CE = V <sub>IL</sub> , OE = V <sub>IH</sub> Write pulse high time         t <sub>WP</sub> 60         —         —         ns           Address setup time         t <sub>AS</sub> 50         —         —         ns           Address hold time         t <sub>AH</sub> 10         —         —         ns           Data setup time         t <sub>DE</sub> 50         —         —         ns           Data setup time         t <sub>DE</sub> 50         —         —         ns           Data setup time         t <sub>DE</sub> 0         —         —         ns           SC to output delay         t <sub>SAC</sub> —         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>IH</sub> OE setup time for SC         t <sub>OES</sub> 0         —         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>IH</sub> OE setup time before read tout low-Z         t <sub>OES</sub> 0         —         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>IH</sub> OE setup time before read tout thethout tout low-Z         t <sub>OES</sub> 0         —         —         <  | Serial clock cycle time                            | t <sub>scc</sub>  | 50  | _   | _   | ns   |  |       |
| Write pulse time   | CE setup time                                      | t <sub>CES</sub>  | 0   | _   | _   | ns   |  |       |
| Write pulse high time         t <sub>WPH</sub> 40         —         ns           Address setup time         t <sub>AS</sub> 50         —         ns           Address hold time         t <sub>AH</sub> 10         —         ns           Data setup time         t <sub>DS</sub> 50         —         ns           Data setup time         t <sub>DH</sub> 10         —         ns           SC to output loded         t <sub>DH</sub> 10         —         ns           SC to output delay         t <sub>SAC</sub> —         —         ns           OE setup time for SC         t <sub>DES</sub> 0         —         —         ns           OE setup time before read         t <sub>DER</sub> 250         —         ns         —           OE setup time before read toutput float         t <sub>DER</sub> 250         —         ns         —           OE setup time before read toutput float         t <sub>DER</sub> 250         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>H</sub> SC to output hold         t <sub>SH</sub> 15         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>H</sub> 1           WE to SC delay time         t <sub>DE</sub> —         —         40         ns         CE = V <sub>IL</sub> , WE = V <sub>H</sub> <  | CE hold time                                       | t <sub>CEH</sub>  | 0   | _   | _   | ns   |  |       |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$   | Write pulse time                                   | $t_{\text{WP}}$   | 60  | _   | _   | ns   | $\overline{CE} = V_{IL}, \ \overline{OE} = V_{IH}$               |       |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$   | Write pulse high time                              | t <sub>WPH</sub>  | 40  | _   | _   | ns   |  |       |
| Data setup time         t <sub>DS</sub> 50         —         ns           Data hold time         t <sub>DH</sub> 10         —         —         ns           SC to output delay         t <sub>SAC</sub> —         —         50         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>H</sub> OE setup time for SC         t <sub>OES</sub> 0         —         —         ns           OE low to output low-Z         t <sub>OEL</sub> 0         —         40         ns           OE setup time before read own write         t <sub>OEWS</sub> 0         —         —         ns           OE setup time before command write         t <sub>OEWS</sub> 0         —         —         ns           SC to output float         t <sub>SH</sub> 15         —         —         ns           SC to output float         t <sub>SH</sub> 15         —         —         ns           SC to output float         t <sub>SH</sub> 15         —         —         ns         CE = OE = V <sub>IL</sub> , WE = V <sub>H</sub> WE to SC delay time         t <sub>SH</sub> 15         —         —         ns         CE = V <sub>IL</sub> , WE = V <sub>H</sub> 1           WE to SC delay time         t <sub>SCH</sub> 50         —         —         ns         SC   | Address setup time                                 | t <sub>AS</sub>   | 50  | _   | _   | ns   |  |       |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$   | Address hold time                                  | t <sub>AH</sub>   | 10  | _   | _   | ns   |  |       |
| SC to output delay $t_{SAC}$ — — 50 ns $\overline{CE} = \overline{OE} = V_{IL}$ , $\overline{WE} = V_{IH}$ $\overline{OE}$ setup time for SC $t_{OES}$ 0 — — ns $\overline{OE}$ low to output low-Z $t_{OEL}$ 0 — 40 ns $\overline{OE}$ setup time before read $t_{OEW}$ 0 — — ns $\overline{OE}$ setup time before read $t_{OEW}$ 0 — — ns $\overline{OE}$ setup time before $t_{OEWS}$ 0 — — ns $\overline{OE} = \overline{OE} = V_{IL}$ , $\overline{WE} = V_{IH}$ $\overline{OE}$ high to output float $t_{SH}$ 15 — — ns $\overline{CE} = \overline{OE} = V_{IL}$ , $\overline{WE} = V_{IH}$ 1 $\overline{WE}$ to SC delay time $t_{WSD}$ 50 — — $\mu_S$ 2 $\overline{OE}$ hold time $t_{SOH}$ 50 — — ns $\overline{OE} = \overline{OE} = V_{IL}$ , $\overline{WE} = V_{IH}$ 1 $\overline{OE}$ hold time $t_{SOH}$ 50 — — ns $\overline{OE} = \overline{OE} = V_{IL}$ $\overline{OE} = V_{IH}$ 1 $\overline{OE} = \overline{OE} = V_{IL}$ $\overline{OE} = V_{IH}$ 1 $\overline{OE} = \overline{OE} = V_{IL}$ $\overline{OE} = V_{IH}$ 1 $\overline{OE} = V_{IL}$ $\overline{OE} = V_{IH}$ 1 $\overline{OE} = V_{IL}$ $\overline$ | Data setup time                                    | t <sub>DS</sub>   | 50  | _   | _   | ns   |  |       |
| $ \begin{array}{ c c c c c c } \hline OE & \text{setup time for SC} & t_{\text{OES}} & 0 &$  | Data hold time                                     | t <sub>DH</sub>   | 10  | _   | _   | ns   |  |       |
|  | SC to output delay                                 | t <sub>SAC</sub>  | _   | _   | 50  | ns   | $\overline{CE} = \overline{OE} = V_{IL}, \overline{WE} = V_{IH}$ |       |
|  | OE setup time for SC                               | t <sub>OES</sub>  | 0   | _   | _   | ns   |  |       |
| $ \begin{array}{ c c c c c } \hline OE & \text{setup time before} \\ \hline command write \\ \hline SC & \text{to output hold} \\ \hline SC & \text{to output hold} \\ \hline CE & \text{injustice} \\ \hline DE & \text{high to output float} \\ \hline DE & \text{high time for output float} \\ \hline DE & \text{high to output float} \\ \hline DE & \text{high time for output float} \\ \hline DE & \text{high to output float} \\ \hline DE & \text{high to output float} \\ \hline DE & \text{high time for output float} \\ \hline DE & \text{high to output float} \\ \hline DE & \text{high to output float} \\ \hline DE & \text{high to device ready} \\ \hline DE & \text{high time for output float} \\ \hline DE & high time for out$  | OE low to output low-Z                             | t <sub>OEL</sub>  | 0   | _   | 40  | ns   |  |       |
| command write $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$   | OE setup time before read                          | t <sub>OER</sub>  | 250 | _   | _   | ns   |  |       |
|  | •  | t <sub>OEWS</sub> | 0   | _   | _   | ns   |  |       |
| $\begin{array}{ c c c c c c }\hline WE to SC delay time & t_{wSD} & 50 & & \mu s & 2\\\hline \hline RES to $\overline{CE}$ setup time & t_{RP} & 1 & & ms\\ \hline SC to $\overline{OE}$ hold time & t_{SOH} & 50 & & ns\\ \hline SC pulse width & t_{SP} & 20 & & ns\\ \hline SC pulse low time & t_{SPL} & 20 & & ns\\ \hline SC setup time for $\overline{CE}$ & t_{SCS} & 0 & & ns\\ \hline \hline CDE setup time for $\overline{WE}$ & t_{CDS} & 0 & & ns\\ \hline \hline CDE hold time for $\overline{WE}$ & t_{CDH} & 20 & & ns\\ \hline \hline V_{cc}$ setup time for $\overline{RES}$ & t_{VRS} & 1 & & \mu s & $\overline{CE} = V_{IH}$\\ \hline \hline RES to $V_{cc}$ hold time & t_{VRH} & 1 & & \mu s & $\overline{CE} = V_{IH}$\\ \hline \hline CE setup time for $\overline{RES}$ & t_{CESR} & 1 & & \mu s\\ \hline RDY/Busy undefined for $V_{cc}$ & t_{DFP} & 0 & & ns\\ \hline \hline CE pulse high time & t_{CPH} & 200 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline \hline CE, $\overline{WE}$ setup time for $\overline{RES}$ & t_{CWRS} & 0 & & ns\\ \hline CE, $\overline{WE}$ setup time for $\overline{WE}$ & t_{CWRS} & 0 & & ns\\ \hline CE, $\overline{WE}$ setup time for $\overline{WE}$ & t_{CWRS} & 0 & & ns\\ \hline CE, $\overline{WE}$ setup time for $\overline{WE}$ & t_{CWRS} & 0 & & ns\\ \hline CE, $\overline{WE}$ set$   | SC to output hold                                  | t <sub>sh</sub>   | 15  | _   | _   | ns   | $\overline{CE} = \overline{OE} = V_{IL}, \overline{WE} = V_{IH}$ |       |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$   | OE high to output float                            | t <sub>DF</sub>   | _   | _   | 40  | ns   | $\overline{CE} = V_{IL}, \overline{WE} = V_{IH}$                 | 1     |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | WE to SC delay time                                | t <sub>WSD</sub>  | 50  | _   | _   | μs   |  | 2     |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | RES to CE setup time                               | t <sub>RP</sub>   | 1   | _   | _   | ms   |  |       |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | SC to OE hold time                                 | t <sub>soh</sub>  | 50  | _   | _   | ns   |  |       |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | SC pulse width                                     | t <sub>SP</sub>   | 20  | _   | _   | ns   |  |       |
|  | SC pulse low time                                  | t <sub>SPL</sub>  | 20  | _   | _   | ns   |  |       |
|  | SC setup time for CE                               | t <sub>scs</sub>  | 0   | _   | _   | ns   |  |       |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  | CDE setup time for WE                              | t <sub>CDS</sub>  | 0   | _   | _   | ns   |  |       |
|  | CDE hold time for WE                               | t <sub>CDH</sub>  | 20  | _   | _   | ns   |  |       |
|  | V <sub>cc</sub> setup time for RES                 | t <sub>VRS</sub>  | 1   | _   | _   | μs   | CE = V <sub>IH</sub>   |       |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$   | $\overline{\rm RES}$ to $\rm V_{\rm CC}$ hold time | $t_{VRH}$         | 1   | _   | _   | μs   | CE = V <sub>IH</sub>   |       |
| off  | CE setup time for RES                              | t <sub>CESR</sub> | 1   | _   | _   | μs   |  |       |
| $\overline{\text{CE}}$ pulse high time $t_{\text{CPH}}$ 200 — ns $\overline{\text{CE}}$ , $\overline{\text{WE}}$ setup time for $\overline{\text{RES}}$ $t_{\text{CWRS}}$ 0 — ns   |  | t <sub>DFP</sub>  | 0   | _   | _   | ns   |  |       |
| $\overline{\text{CE}}, \overline{\text{WE}}$ setup time for $\overline{\text{RES}}$ $t_{\text{CWRS}}$ 0 — ns   | RES high to device ready                           | t <sub>BSY</sub>  | _   | _   | 1   | ms   |  |       |
|  | CE pulse high time                                 | t <sub>CPH</sub>  | 200 | _   | _   | ns   |  |       |
| $\overline{\text{RES}}$ to $\overline{\text{CE}}, \overline{\text{WE}}$ hold time $t_{\text{CWRH}} = 0$ — ns   | CE, WE setup time for RES                          | t <sub>CWRS</sub> | 0   | _   | _   | ns   |  |       |
|  | RES to CE, WE hold time                            | t <sub>CWRH</sub> | 0   |     |     | ns   |  |       |

| Parameter                        | Symbol            | Min | Тур | Max | Unit | Test conditions | Notes |
|----------------------------------|-------------------|-----|-----|-----|------|-----------------|-------|
| SC setup for WE                  | t <sub>sw</sub>   | 50  | _   | _   | ns   |                 |       |
| CE hold time for OE              | t <sub>coh</sub>  | 0   | _   | _   | ns   |                 |       |
| SA (2) to CA (2) delay time      | t <sub>SCD</sub>  | _   | _   | 30  | μs   |                 |       |
| RDY/Busy setup for SC            | t <sub>RS</sub>   | 200 | _   | _   | ns   |                 |       |
| Time to device busy on read mode | t <sub>DBR</sub>  | _   | _   | 1   | μs   |                 |       |
| Busy time on reset mode          | t <sub>RBSY</sub> | _   | 45  | _   | μs   |                 |       |

Notes: 1.  $t_{DF}$  is a time after which the I/O pins become open.

<sup>2.</sup>  $t_{\text{WSD}}$  (min) is specified as a reference point only for SC, if  $t_{\text{WSD}}$  is greater than the specified  $t_{\text{WSD}}$  (min) limit, then access time is controlled exclusively by  $t_{\text{SAC}}$ .

# Program, Erase and Erase Verify

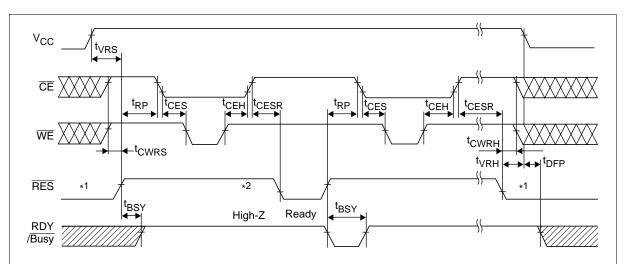
| Parameter                                 | Symbol            | Min | Тур | Max  | Unit | Test conditions       | Note |
|---|-------------------|-----|-----|------|------|-----------------------|------|
| Write cycle time                          | t <sub>cwc</sub>  | 120 | _   | _    | ns   |                       |      |
| Serial clock cycle time                   | $t_{\text{scc}}$  | 50  | _   | _    | ns   |                       |      |
| CE setup time                             | $t_{\text{CES}}$  | 0   | _   | _    | ns   |                       |      |
| CE hold time                              | t <sub>CEH</sub>  | 0   | _   | _    | ns   |                       |      |
| Write pulse time                          | $t_{WP}$          | 60  | _   | _    | ns   |                       |      |
| Write pulse high time                     | $t_{\text{WPH}}$  | 40  | _   | _    | ns   |                       |      |
| Address setup time                        | t <sub>AS</sub>   | 50  | _   | _    | ns   |                       |      |
| Address hold time                         | t <sub>AH</sub>   | 10  | _   | _    | ns   |                       |      |
| Data setup time                           | t <sub>DS</sub>   | 50  | _   | _    | ns   |                       |      |
| Data hold time                            | t <sub>DH</sub>   | 10  | _   | _    | ns   |                       |      |
| OE setup time before command write        | t <sub>OEWS</sub> | 0   | _   | _    | ns   |                       |      |
| OE setup time before status polling       | t <sub>OEPS</sub> | 40  | _   | _    | ns   |                       |      |
| OE setup time before read                 | t <sub>OER</sub>  | 250 | _   | _    | ns   |                       |      |
| Time to device busy                       | t <sub>DB</sub>   | _   | _   | 150  | ns   |                       |      |
| Time to device busy on read mode          | t <sub>DBR</sub>  | _   | _   | 1    | μs   |                       |      |
| Auto erase time                           | t <sub>ASE</sub>  | _   | 1.5 | 5.0  | ms   |                       |      |
| Auto program time<br>Program(1), (3)      | t <sub>ASP</sub>  | _   | 3.0 | 20.0 | ms   |                       |      |
| Program(2)                                | t <sub>ASP</sub>  | _   | 2.5 | 20.0 | ms   |                       |      |
| Program(4),<br>Data recovery write        | t <sub>ASP</sub>  | _   | 3.5 | 30.0 | ms   |                       |      |
| WE to SC delay time                       | t <sub>wsD</sub>  | 50  | _   | _    | μs   |                       |      |
| WE to SC delay time on recovery read mode | t <sub>WSDR</sub> | 2   | _   | _    | μs   |                       |      |
| CE pulse high time                        | t <sub>CPH</sub>  | 200 | _   | _    | ns   |                       |      |
| SC pulse width                            | t <sub>SP</sub>   | 20  | _   | _    | ns   |                       |      |
| SC pulse low time                         | t <sub>SPL</sub>  | 20  | _   | _    | ns   |                       |      |
| Data setup time for SC                    | t <sub>sds</sub>  | 0   | _   | _    | ns   |                       |      |
| Data hold time for SC                     | t <sub>SDH</sub>  | 30  | _   | _    | ns   | CDE = V <sub>IL</sub> |      |
| SC setup for WE                           | t <sub>sw</sub>   | 50  | _   | _    | ns   |                       |      |
| SC setup for CE                           | t <sub>scs</sub>  | 0   | _   | _    | ns   |                       |      |
| SC hold time for WE                       | t <sub>schw</sub> | 20  | _   | _    | ns   |                       |      |
| CE to output delay                        | t <sub>CE</sub>   | _   |     | 120  | ns   |                       |      |

| Parameter                                 | Symbol            | Min | Тур | Max | Unit | Test conditions | Note |
|---|-------------------|-----|-----|-----|------|-----------------|------|
| OE to output delay                        | t <sub>OE</sub>   | _   | _   | 60  | ns   |                 |      |
| OE high to output float                   | t <sub>DF</sub>   | _   | _   | 40  | ns   |                 | 1    |
| RES to WE setup time                      | t <sub>RP</sub>   | 1   | _   | _   | ms   |                 |      |
| CDE setup time for WE                     | t <sub>CDS</sub>  | 0   | _   | _   | ns   |                 |      |
| CDE hold time for WE                      | t <sub>CDH</sub>  | 20  | _   | _   | ns   |                 |      |
| CDE setup time for SC                     | t <sub>CDSS</sub> | 1.5 | _   | _   | μs   |                 |      |
| CDE hold time for SC                      | t <sub>CDSH</sub> | 30  | _   | _   | ns   |                 |      |
| Next cycle ready time                     | t <sub>RDY</sub>  | 0   | _   | _   | ns   |                 |      |
| CDE to OE hold time                       | t <sub>CDOH</sub> | 50  | _   | _   | ns   |                 |      |
| CDE to output delay                       | t <sub>CDAC</sub> | _   | _   | 50  | ns   |                 |      |
| CDE to output invalid                     | t <sub>CDF</sub>  | _   | _   | 100 | ns   |                 |      |
| CE setup time for OE                      | t <sub>cos</sub>  | 0   | _   | _   | ns   |                 |      |
| CE hold time for OE                       | t <sub>coh</sub>  | 0   | _   | _   | ns   |                 |      |
| CDE to OE setup time                      | t <sub>cdos</sub> | 20  | _   | _   | ns   |                 |      |
| OE setup time for SC                      | t <sub>OES</sub>  | 0   | _   | _   | ns   |                 |      |
| OE low to output low-Z                    | t <sub>OEL</sub>  | 0   | _   | 40  | ns   |                 |      |
| SC to output delay                        | t <sub>sac</sub>  | _   | _   | 50  | ns   |                 |      |
| SC to output hold                         | t <sub>sh</sub>   | 15  | _   | _   | ns   |                 |      |
| RDY/Busy setup for SC                     | t <sub>RS</sub>   | 200 | _   | _   | ns   |                 |      |
| CE hold time for WE                       | t <sub>cwh</sub>  | 1.0 | _   | _   | μs   |                 |      |
| CE hold time for WE on recovery read mode | t <sub>CWHR</sub> | 2   | _   | _   | μs   |                 |      |
| WE hold time for WE                       | $t_{\text{wwH}}$  | 1   | _   | _   | μs   |                 |      |
| Busy time on read mode                    | t <sub>RRSY</sub> | _   | 45  | _   | μs   |                 |      |

Note: 1.  $t_{DF}$  is a time after which the I/O pins become open.

# **Timing Waveforms**

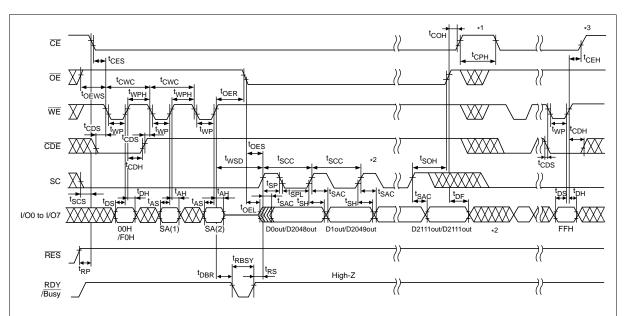
### Power on and off Sequence



Notes: 1. RES must be kept at the V<sub>ILR</sub> level referred to DC characteristics at the rising and falling edges of V<sub>CC</sub> to guarantee data stored in the chip.
2. RES must be kept at the V<sub>IHR</sub> level referred to DC characteristics while I/O7 outputs the V<sub>OL</sub> level in the status data polling and RDY/Busy outputs the V<sub>OL</sub> level.

- 3. Undefined

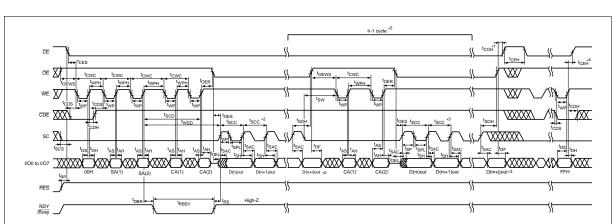
### Serial Read (1) (2) Timing Waveform



Notes: 1. The status returns to the standby at the rising edge of  $\overline{CE}$ .

- 2. Output data is not valid after the number of the SC pulse exceeds 2112 and 64 in the serial read mode (1) and (2), respectively.
- 3. After any commands are written, the status can return to the standby after the command FFH is input and  $\overline{\text{CE}}$  turns to the V<sub>IH</sub> level.

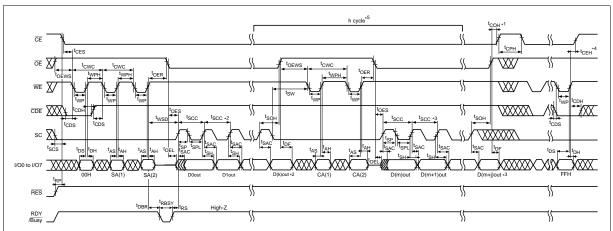
### Serial Read (1) with CA before SC Timing Waveform



Notes: 1. The status returns to the Standby at the rising edge of  $\overline{\text{CE}}$ .

- 2. Output data is not valid after the number of the SC pulse exceeds (2112-n). (i  $\leq$  2111-n, 0  $\leq$  n  $\leq$  2111)
- 3. Output data is not valid after the number of the SC pulse exceeds (2112-m). (j  $\leq$  2111-m,  $0 \leq$  m  $\leq$  2111)
- After any commands are written, the status can return to the standby after the command FFH is input and CE turns
  to the V<sub>IH</sub> level.
- 5. This interval can be repeated (h-1) cycle.  $(1 \le h \le 2048 + 64)$

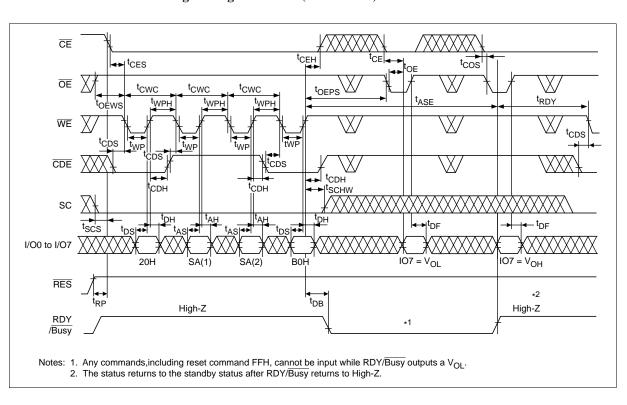
### Serial Read (1) with CA after SC Timing Waveform



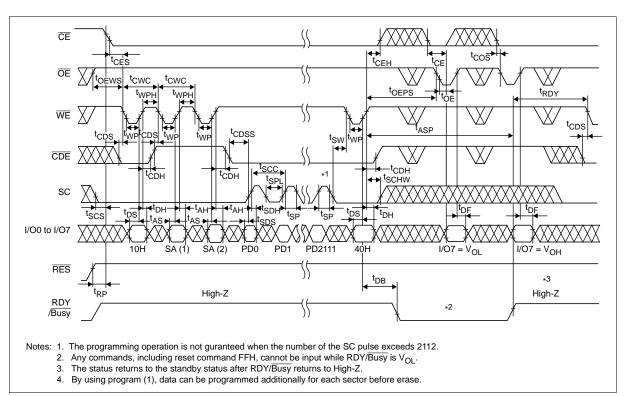
Notes: 1. The status returns to the Standby at the rising edge of  $\overline{\text{CE}}$ .

- 2. Output data is not valid after the number of the SC pulse exceeds 2112. (0  $\leq$  k  $\leq$  2111)
- 3. Output data is not valid after the number of the SC pulse exceeds (2112-m). (j  $\leq$  2111-m, 0  $\leq$  m  $\leq$  2111)
- 4. After any commands are written, the status can return to the standby after the command FFH is input and  $\overline{\text{CE}}$  turns to the V<sub>IH</sub> level.
- 5. This interval can be repeated h cycle.  $(1 \le h \le 2048 + 64)$

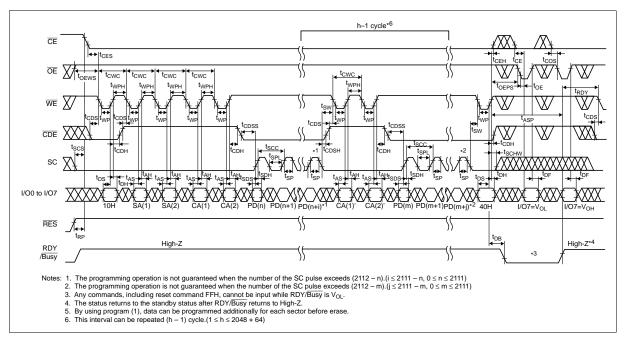
### Erase and Status Data Polling Timing Waveform (Sector Erase)



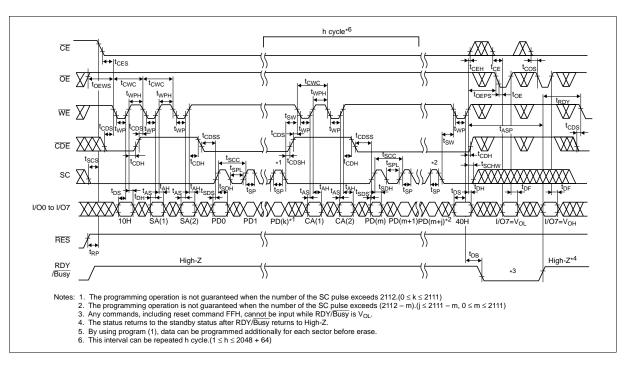
### Program (1) and Status Data Polling Timing Waveform



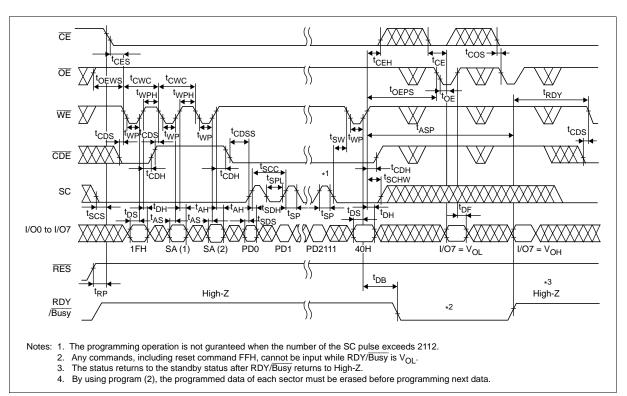
### Program (1) with CA before SC and Status Data Polling Timing Waveform



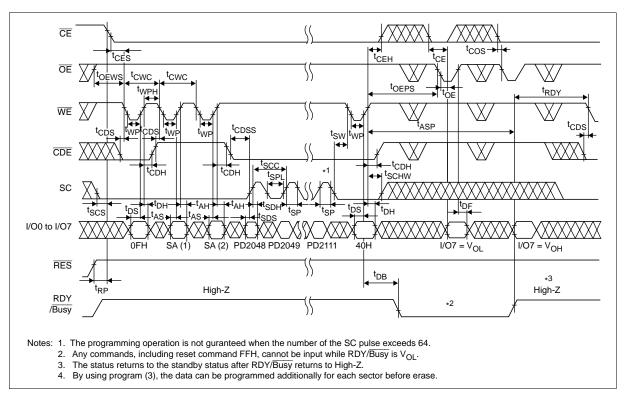
### Program (1) with CA after SC and Status Data Polling Timing Waveform



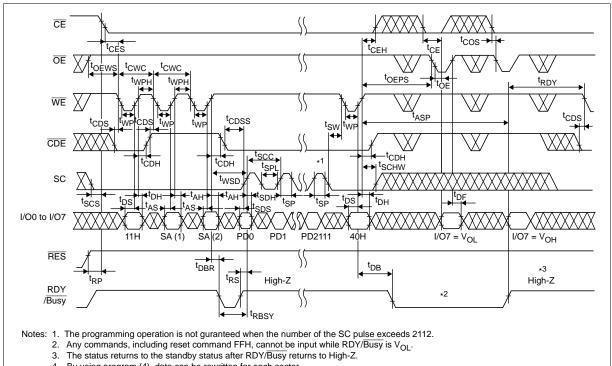
### Program (2) and Status Data Polling Timing Waveform



## Program (3) and Status Data Polling Timing Waveform

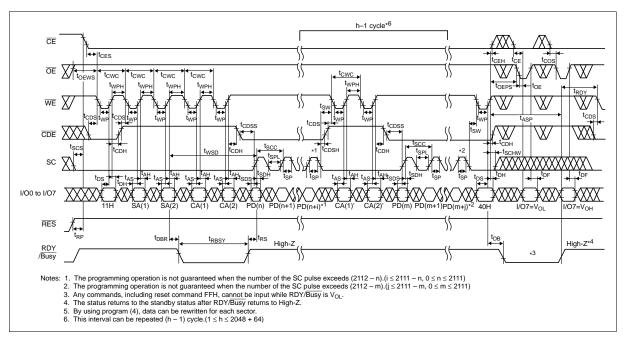


### Program (4) and Status Data Polling Timing Waveform

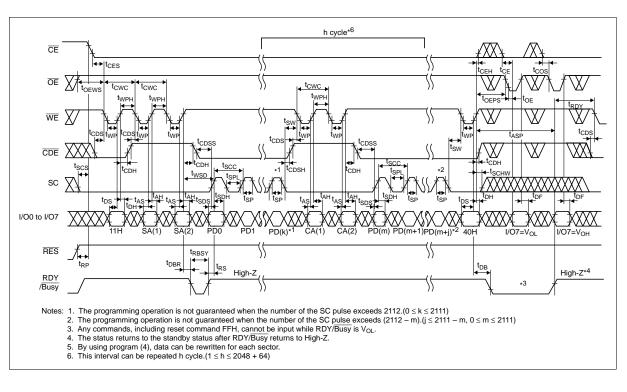


4. By using program (4), data can be rewritten for each sector.

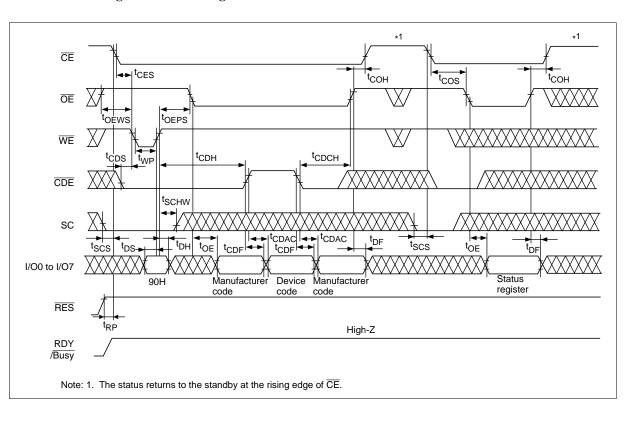
### Program (4) with CA before SC and Status Data Polling Timing Waveform



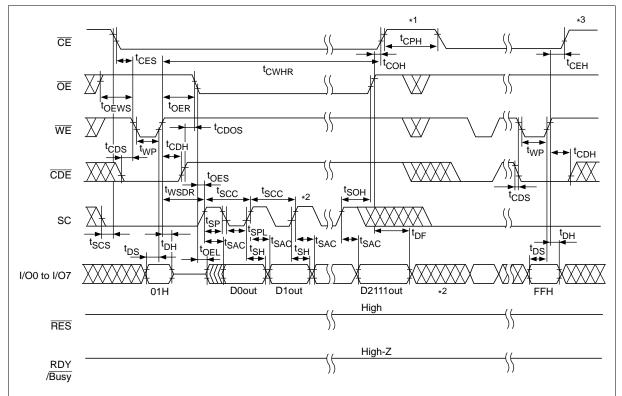
### Program (4) with CA after SC and Status Data Polling Timing Waveform



## **ID** and Status Register Read Timing Waveform



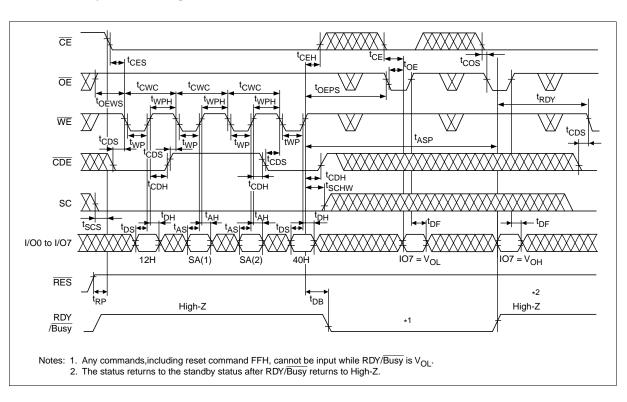
### **Data Recovery Read Timing Waveform**



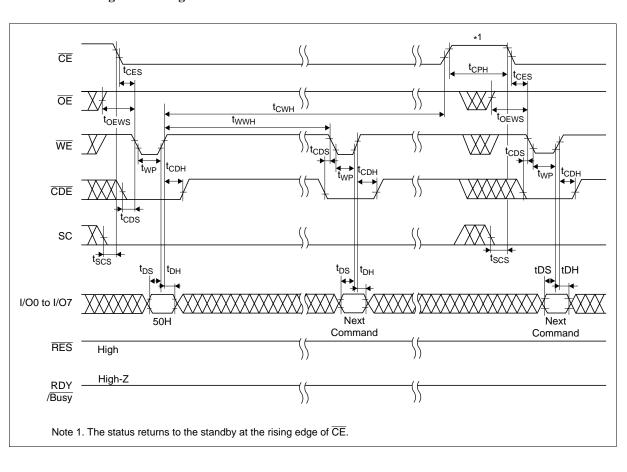
Notes: 1. The status returns to the standby at the rising edge of  $\overline{\text{CE}}$ .

- 2. Output data is not valid after the number of the SC pulse exceed 2112 in the recovery data read mode.
- 3. After any commands are written, the status can turns to the standby after the command FFH is input and  $\overline{\text{CE}}$  turns to the V<sub>IH</sub> level.

### **Data Recovery Write Timing Waveform**



## **Clear Status Register Timing Waveform**



## **Function Description**

**Status Register:** The HN29W25611 outputs the operation status data as follows: I/O7 pin outputs a  $V_{OL}$  to indicate that the memory is in either erase or program operation. The level of I/O7 pin turns to a  $V_{OH}$  when the operation finishes. I/O5 and I/O4 pins output  $V_{OL}$ s to indicate that the erase and program operations complete in a finite time, respectively. If these pins output  $V_{OH}$ s, it indicates that these operations have timed out. When these pins monitor, I/O7 pin must turn to a  $V_{OH}$ . To execute other erase and program operation, the status data must be cleared after a time out occurs. From I/O0 to I/O3 pins are reserved for future use. The pins output  $V_{OL}$ s and should be masked out during the status data read mode. The function of the status register is summarized in the following table .

| I/O  | Flag definition | Definition   |
|------|-----------------|--|
| I/O7 | Ready/Busy      | $V_{OH}$ = Ready, $V_{OL}$ = Busy  |
| I/O6 | Reserved        | Outputs a $V_{\text{OL}}$ and should be masked out during the status data poling mode. |
| I/O5 | Erase check     | $V_{OH}$ = Fail, $V_{OL}$ = Pass   |
| I/O4 | Program check   | $V_{OH}$ = Fail, $V_{OL}$ = Pass   |
| I/O3 | Reserved        | Outputs a $V_{\text{OL}}$ and should be masked out during the status data poling mode. |
| I/O2 | Reserved        |  |
| I/O1 | Reserved        |  |
| I/O0 | Reserved        |  |

## **Requirement for System**

### **Specifications**

| Item                        | Min    | Тур | Max    | Unit       |
|-----------------------------|--------|-----|--------|------------|
| Usable sectors (initially)  | 16,057 | _   | 16,384 | sector     |
| Spare sectors               | 290    | _   | _      | sector     |
| ECC (Error Correction Code) | 3      | _   | _      | bit/sector |
| Program/Erase endurance     | _      | _   | 10⁵    | cycle      |

#### **Unusable Sector**

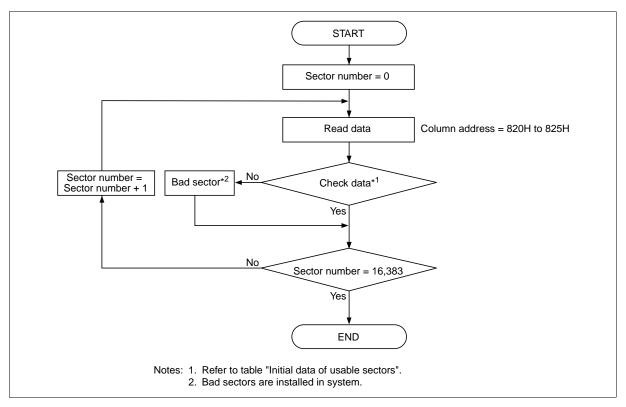
Initially, the HN29W25611 includes unusable sectors. The unusable sectors must be distinguished from the usable sectors by the system as follows.

1. Check the partial invalid sectors in the devices on the system. The usable sectors were programmed the following data. Refer to the flowchart "Indication of unusable sectors".

### **Initial Data of Usable Sectors**

| Column address | 0H to 81FH | 820H | 821H | 822H | 823H | 824H | 825H | 826H to 83FH |
|----------------|------------|------|------|------|------|------|------|--------------|
| Data           | FFH        | 1CH  | 71H  | C7H  | 1CH  | 71H  | C7H  | FFH          |

2. Do not erase and program to the partial invalid sectors by the system.

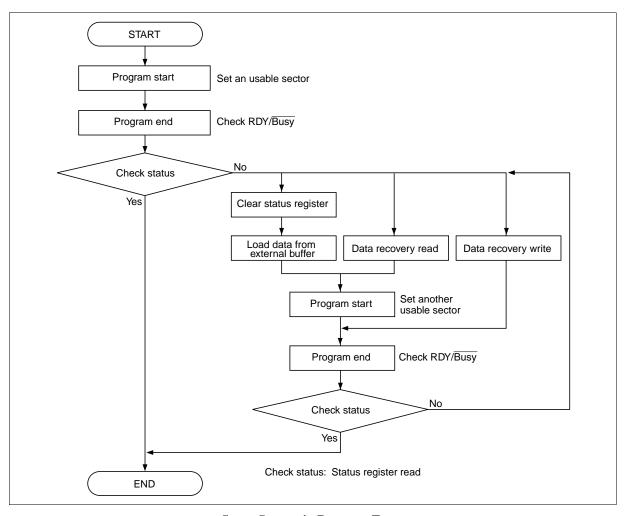


**Indication of Unusable Sectors** 

### Requirements for High System Reliability

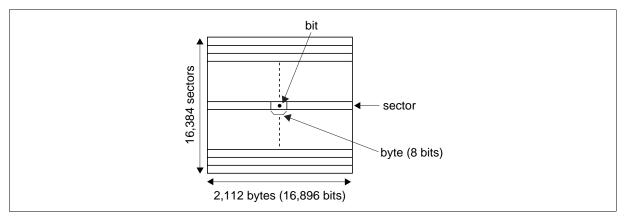
The device may fail during a program, erase or read operation due to write or erase cycles. The following architecture will enable high system reliability if a failure occurs.

- 1. For an error in read operation: An error correction more than 3-bit error correction per each sector read is required for data reliability.
- 2. For errors in program or erase operations: The device may fail during a program or erase operation due to write or erase cycles. The status register indicates if the erase and program operation complete in a finite time. When an error happens in the sector, try to reprogram the data into another sector. Avoid further system access to the sector that error happens. Typically, recommended number of a spare sectors are 1.8% of initial usable 16,057 sectors by each device. If the number of failed sectors exceeds the number of the spare sectors, usable data area in the device decreases. For the reprogramming, do not use the data from the failed sectors, because the data from the failed sectors are not fixed. So the reprogram data must be the data reloaded from outer buffer, or use the Data recovery read mode or the Data recovery write mode (see the "Mode Description" and under figure "Spare Sectors in Program Error"). To avoid consecutive sector failures, choose addresses of spare sectors as far as possible from the failed sectors.



**Spare Sectors in Program Error** 

## **Memory Structure**



Bit: Minimum unit of data.

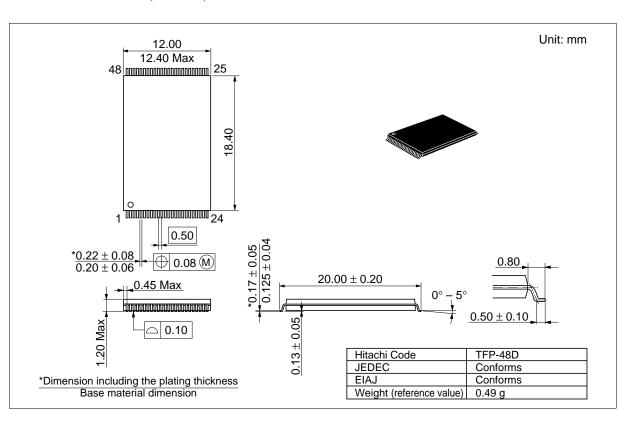
Byte: Input/output data unit in programming and reading. (1 byte = 8 bits)

Sector: Page unit in erase, programming and reading. (1 sector = 2,112 bytes = 16,896 bits)

Device: 1 device = 16,384 sectors.

# **Package Dimensions**

### **HN29W25611T Series** (TFP-48D)



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# **Revision Record**

| Rev. | Date          | Contents of Modification  | Drawn by  | Approved by |
|------|---------------|---|-----------|-------------|
| 0.0  | Jan. 8, 1999  | Initial issue   | M. Shirai | T. Totsuka  |
| 0.1  | Jun. 28, 1999 | Deletion of $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ operation Sector program time: 1.0 ms to 3.0 ms Single sector erase time: 1.0 ms to 1.5 ms Error correction: more than 1 bit to more than 3-bit Command Definition: Addition of Data recovery read item Addition of description for Data recovery read Change of Status transition AC Characteristics  Change of parameter name: $t_{OEPS}$ to $t_{OER}$ to $t_{OER}$ min: 200 ns to 250 ns $t_{OEPS}$ min: 200 ns to 40 ns $t_{ASE}$ typ: 1.0 ms to 1.5 ms $t_{ASE}$ (Program1, 3) typ: 1.5 ms to 3.0 ms $t_{ASE}$ (Program2) typ: 1.0 ms to 2.5 ms $t_{ASE}$ (Program2) max: 37.0 ms to 20.0 ms $t_{ASE}$ (Program3) max: 35.0 ms to 20.0 ms $t_{ASE}$ (Program3) max: 40.0 ms to 30.0 ms $t_{CDSH}$ min: 0 ns to 30 ns $t_{OEL}$ min: — to 40 ns Change of Timing Waveforms Serial read (1) (2), Serial read (1) with CA before SC, Serial read (1) with CA after SC and Data recovery read Notes  Change of description for Enable high system reliability 1 Deletion of description for Enable high system reliability 3 and Prohibit the command except command definition | M. Shirai | H. Uchida   |
| 1.0  | Dec. 10, 1999 | Features: Change of required architecture Change of table for Command definition Mode Description Addition of description for Data Recovery Write Addition of figure for Data Recovery Write Change of Status Transition Timing Waveforms: Addition of Data Recovery Write Notes: Change all item Addition of flowcharts Change of contents Addition of Memory structure  |           |             |